USB Thumb Drive
Designer Reference Manual

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The following revision history table summarizes changes contained in this document. For your convenience, the page number designators have been linked to the appropriate location.

## Revision History

<table>
<thead>
<tr>
<th>Date</th>
<th>Revision Level</th>
<th>Description</th>
<th>Page Number(s)</th>
</tr>
</thead>
<tbody>
<tr>
<td>September, 2004</td>
<td>N/A</td>
<td>Initial release</td>
<td>N/A</td>
</tr>
</tbody>
</table>

USB Thumb Drive Designer Reference Manual, Rev. 0

Freescale Semiconductor
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Chapter 1  
System Overview

1.1 Introduction

This manual describes a reference design of USB2.0 Thumb Drive solution by using the MC9S12UF32 microcontroller.

The whole system consists of a NAND Flash memory and MC9S12UF32. All hardware schematic diagrams and firmware source codes are available as reference materials.

1.2 Features

- USB2.0 high speed and full speed compliance
- Windows 2000 and Windows XP compatible
- No specific driver required
- Small size and easy to use
- Store all your data, pictures, music, and movies

Figure 1-1. Enlarged Photograph of the USB Thumb Drive Reference Design
1.3 System Overview

The system consists of two functional devices: the MC9S12UF32 (hereafter referred as UF32) and the NAND Flash memory chip.

The overall system operation, I/O interface, and power are controlled by MCU.

1.4 Mass Storage

In data write to NAND Flash, the data transmits with the Logical Block Address (hereafter referred as LBA) from the PC via USB2.0 interface to the UF32 Integrated Queue (hereafter referred as IQUE) RAM as a buffer, which will transmit the data to NAND Flash once the buffer is full.

In data read from NAND Flash, the data received from NAND Flash to UF32 IQUE RAM as a buffer, which will transmit the data to PC via USB2.0 interface.

UF32 also builds the logical block to physical block table for the logical to physical block conversion for read/write operation.
Chapter 2
Basic Function

2.1 Introduction

A Thumb Drive is designed as the mass storage for the data read and write via PC USB2.0 host. The basic functions are required as below:

1. Plug & Play
2. Read and Write
3. Write-Protect Switch
4. Unplug

2.2 Plug and Play

When you plug the device into the USB port of your computer, you will see a “Removable Disk” icon in the file manager window.

![Figure 2-1. Removable Disk](image)

Figure 2-1 shows the Removable Disk as F: drive since this system’s CD-ROM is assigned as E: drive.

2.3 Read and Write

You can retrieve or store files in the device as a hard disk. The read/write operation of the device is the same as that of a hard disk.
2.4 Write-Protect Switch

When you move the write-protect switch to the “ON” position, you cannot write any files into the Thumb Drive. You still can view and read the files in the device. The “Write-Protect” switch can only be activated when the Thumb Drive is plugged in the computer’s USB port.

2.5 Unplug

You can remove the device after you finish the action with the device. However, in Windows ME and Windows 2000, please follow the safe removal procedure. You can find a safe removal icon on your computer’s notification area.

Double click the “safe removal” icon; the “Unplug or Eject Hardware” window will be pop up. You can select the device you want to remove. Then, click the [Stop] button.

After that you can unplug the device from the USB port of your computer.

When you want to remove the USB FLASH DRIVE device, make sure the LED is not flashing. When the LED flashes quickly, there are some traffic on going between the OS and the USB FLASH DRIVE device. Don’t remove the USB FLASH DRIVE at this moment. Otherwise, it will cause some damages to the data or even the USB FLASH DRIVE device itself.

**WARNING**

In Windows ME and Windows 2000 operating systems, you must use the hardware safe removal procedure, otherwise data loss caused by the “write cache” issue may happen.

![Figure 2-2. Safe Removal Icon](image)

Figure 2-2 shows the Safely Remove Hardware icon for user unplug the USB MS device.
**Figure 2-3. Unplug the USB Mass Storage Device**

*Figure 2-3* shows the Unplug USB Mass Storage device. User has to click it and select “Stop USB Mass Storage Device - Drive (F:)” before physically unplugging the Thumb Drive.
Chapter 3
Hardware

3.1 Introduction
The UF32 has 32K-bytes of Flash memory, 30MHz bus speed, a Smart Media (hereafter referred as SM) module and appropriate number of I/O pins makes this MCU suited for thumb drive solutions. The main features of the reference design include:
- USB interface
- 480Mbps data transfer rate
- LED display

3.2 System Overview
The thumb drive consists of the UF32, the NAND Flash. Figure 3-1 shows the block diagram of the system

![Figure 3-1. Thumb Drive Block Diagram](image)

3.2.1 UF32 Microcontroller
The functions of the UF32 are to get the USB Mass Storage (hereafter referred as MS) command from PC via USB 2.0 interface and decodes them for MS read/write.

3.2.2 NAND Flash
The TC58DVG02A1 is a single 3.3 V 1-Gbit (1,107,296,256) bit NAND Electrically Erasable and Programmable Read-Only Memory (NAND E2PROM), organized as 528 bytes, 32 pages, and 8192 blocks. The device has a 528-byte static register which allows program and read data to be transferred between the register and the memory cell array in 528-byte increments. The erase operation is implemented in a single block unit (16K-bytes 512 bytes: 528 bytes 32 pages). The TC58DVG02A1 is a serial-type memory device which utilizes the I/O pins for both address and data input/output as well as for command inputs. The erase and program operations are automatically executed making the device most suitable for applications such as solid-state file storage, voice recording, image file memory for still cameras and other systems which require high-density non-volatile memory data storage.
3.2.3 Voltage Configuration

Figure 3-2 shows the voltage configuration for UF32.

3.2.4 Integrated Queue Module (IQUE)

Figure 3-3 shows the Integrated Queue Module (hereafter referred as IQUE). The IQUE module is designed to allow the data transfer to and from between NAND Flash memory and PC host without CPU interruption. It can help to minimize the overhead at CPU side.
Chapter 4
Firmware

4.1 System Software Architecture

Figure 4-1 shows the system software architecture for the UF32 Thumb Drive. The mini-kernel is designed for the multi-tasks operation. In this application, mini-kernel is mainly working for the USB event task after system initialization. The initialization subroutines are for the system initialization, such as for timer module, 3.3 voltage regulator, SM module, IQUE module, IQUE RAM mapping, SM RAM for logical to physical look up table and USB module.

The main program continually checks the tasks and to serve the event once the request is made. It will decode to invoke the SCSI commands if the request is made from PC via USB2.0 interface.

All data will pass through the IQUE RAM and read/write to NAND Flash.
4.2 UF32 Memory Mapping for Thumb Drive

Figure 4-2 shows memory mapping for Thumb Drive application. It is to configure 2K x 10-bit RAM for RAM block 0 ($0800–$0FCF) and RAM block 1 ($1000–$17CF). The system RAM is located from $1BC4 to $1FFF. The firmware is stored to upper flash block $C000–$FFFF.

The RAM block (0,1) are designed to store the look up tables for the logical to physical block conversion. The RAM block 0 is to store the conversion table for the physical segment 0 of the NAND Flash, which is to store boot record, FAT table, and directories content. The RAM block 1 is to store the conversion tables for the physical segment 1 to 3 of the NAND Flash for the file data content.

NOTES:
QRAM is mapped to $2000–$25FF by writing 0x21 to the INITEE register.
SM Mode is enabled by setting the SMMODE bit of the SMRAM configuration register.
4.3 Logical to Physical interrelation

Figure 4-3 shows the interrelation between PBA and LBA. The cluster is configured as 16K (32 sectors or pages) in the above example. Normally, the cluster can be configured as 1K, 2K, 4K, etc., in FAT16 format.

4.4 Logical to Physical Block Format

Figure 4-4 shows the logical to physical block format in the Thumb Drive application. The UF32 is working from the Device Driver down to NAND Flash physical layer.
4.5 Physical Format

Figure 4-5. Physical Format

Figure 4-5 shows the NAND Flash physical relationship between the blocks and the pages (or sectors). The physical block is defined as memory erase unit and the physical page is defined as memory write/read unit. In this case, one physical page has 512 bytes and one physical block has 32 physical pages.

4.6 Logical Format

Figure 4-6. Logical Format

Figure 4-6 shows the logical format in the Thumb Drive application. FAT16 is selected as the system format, which can be recognized by Windows 2000 and Windows XP.
4.7 Logical to Physical Table

Figure 4-7 shows the logical to physical translation table. It reads the ExtraDataArea of physical block of the NAND Flash to retrieve the logical address and store to the table. For high speed processing, it is desirable to construct a table of alternate blocks, as well as the logical/physical translation table. In this firmware, the RAM block 0 is to store the conversion table for the physical segment 0 of the NAND Flash, which is to store boot record, FAT table and directories content. The RAM block 1 is to store the conversion tables for the physical segment 1 to 3 of the NAND Flash for the file data content.

4.8 SCSI Command Handling Flow

Figure 4-8. SCSI Command Handling Flow
Figure 4-8 shows the flow of the SCSI command handling flow. The host sends the Command Block Wrapper (hereafter referred as CBW) to UF32 via USB2.0 interface. The SCSI command handling firmware will then respond to the host regarding to the corresponding SCSI command.

4.9 SCSI Command Read Packet

Figure 4-9 shows the flow of the SCSI command read packet. The data of the corresponding LBA will be sent to the host via USB2.0 interface once the UF32 receives a SCSI command (0x28). The firmware gets the LBA and determines its corresponding segment for update the logical to physical table “LogToPhyTbl” if necessary. The Physical Block Address (hereafter referred as PBA) can be converted from the “LogToPhyTbl”. The data can be retrieved from NAND Flash according to this PBA by the UF32 and sends them to PC host via USB2.0 interface.

Figure 4-9. SCSI Command Read Packet
Figure 4-10 shows the flow of the SCSI command write packet. Similarly, the data of the corresponding LBA will be sent from host via USB2.0 interface through UF32 IQE module to NAND Flash. The firmware gets the LBA and determines its corresponding segment for update the logical to physical table “LogToPhyTbl” if necessary. The PBA can be converted from the “LogToPhyTbl”. The data can be written to NAND Flash according to this PBA by the UF32 from PC host via USB2.0 interface.
4.11 Write Protection

The write protection feature is implemented by SCSI mode sense command. The software used PORTS bit 4 to detect whether it’s configured as write protection or not during power up and will keep the status until power-off. Thus, it cannot be changed during runtime to minimize the accidental switch over.

4.12 UF32 Thumb Drive Firmware

The UF32 Thumb Drive firmware is to handle the data to and from PC and NAND Flash via IQUE module as read/write operation. Basically, the UF32 CPU does not touch the data while it is being transferred. The data is handled by UF32 IQUE module directly. However, the conversion of LBA and PBA can be done by the UF32 CPU for NAND Flash read/write operation.

In read operation, it is a bit simple since the UF32 Thumb Drive firmware only handles the LBA and PBA conversion and it does not care about the physical block and sector/page relationship.

In write operation, the UF32 Thumb Drive firmware has to take care of the other 31 pages even when there is only 1 page to be updated since a physical block has 32 sectors/page in NAND Flash.

The firmware is to support the typical SCSI commands as shown Table 4-1.

Table 4-1. Typical SCSI Commands

<table>
<thead>
<tr>
<th>Code</th>
<th>Command</th>
</tr>
</thead>
<tbody>
<tr>
<td>0X00</td>
<td>Test Unit Ready (6)</td>
</tr>
<tr>
<td>0X03</td>
<td>Request Sense (6)</td>
</tr>
<tr>
<td>0X12</td>
<td>Inquiry (6)</td>
</tr>
<tr>
<td>0X1A</td>
<td>Mode Sense (6)</td>
</tr>
<tr>
<td>0X1E</td>
<td>Prevent Allow Media Removal (6)</td>
</tr>
<tr>
<td>0X25</td>
<td>Read Capacity (10)</td>
</tr>
<tr>
<td>0X28</td>
<td>Read (10)</td>
</tr>
<tr>
<td>0X2A</td>
<td>Write (10)</td>
</tr>
<tr>
<td>0X2F</td>
<td>Verify (10)</td>
</tr>
<tr>
<td>0X5A</td>
<td>Mode Sense (6)</td>
</tr>
</tbody>
</table>
Chapter 5
Testing and Customizing

5.1 Testing
The Thumb Drive reference design was tested under different Windows Operating Systems on several different PCs.

- USB compliance test using Command Verifier version 1.2
- Compatibility tests under Windows 2000 and XP
- Compatibility tests under AMD 750, Intel 810 and 865 chip set desktops, IBM Thinkpad T23 and Dell Latitude C640 notebook PCs.

5.2 Customizing

5.2.1 Hardware

5.2.1.1 NAND Flash
The Toshiba NAND Flash used in this reference design was a random selection. User can choose from any NAND Flash vendors.

5.2.2 Firmware

5.2.2.1 NAND Flash Size

- 512 Mbit NAND flash size is used in this reference design.
- User needs to change the parameters in boot_64M() subroutine if a 1-Gbit NAND Flash size is used.
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